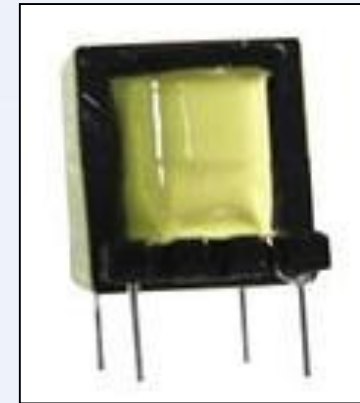
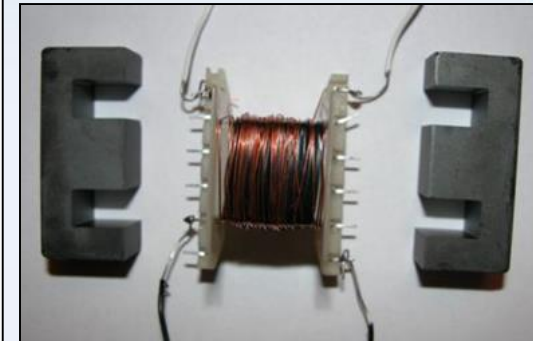
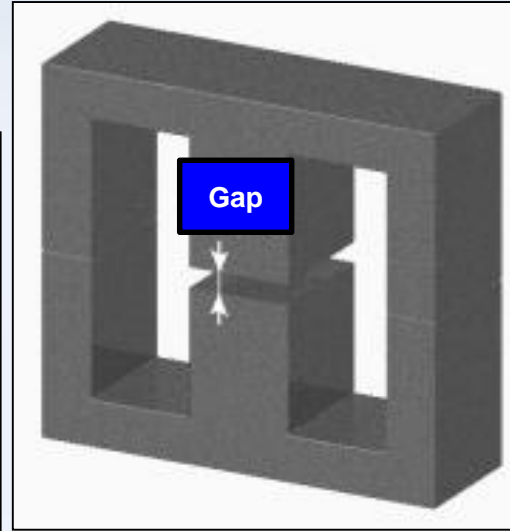
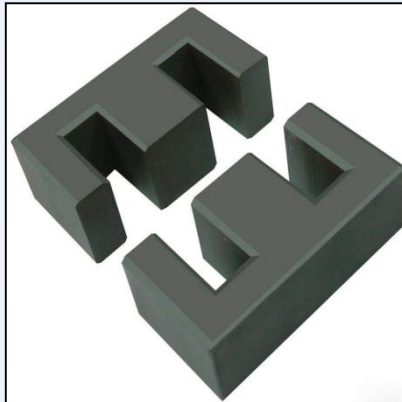




# Speedofer Ferrite Cores Grinding Process Elaboration



- Post Sintered Cores
- Cannot use in the application due to uneven surface & Un-gapped
- (Uneven Surface makes the Cores produce fluctuating Inductance that is dangerous to the Circuits)

- Post Grinding Cores (Bottom & Top)
- Cannot use in the application due to Un-gapped Cores
- (Cores needs to be Gapped in the Limbs to make them produce the designed Inductance Value to the Circuit)

- Post Gapped Cores (Limbs)
- Ready to ship to the customers

- Cores are assembled in the Transformers / Inductors to eventually use them in the PCB Assemblies.
- (Speedofer Clients Processes)

Grinding accuracy 0.01mm